

MFE2010 (SILICON)

MFE2011

MFE2012

Silicon N-channel depletion mode (Type A) junction field-effect transistors designed for chopper applications.



CASE 22
(TO-18)

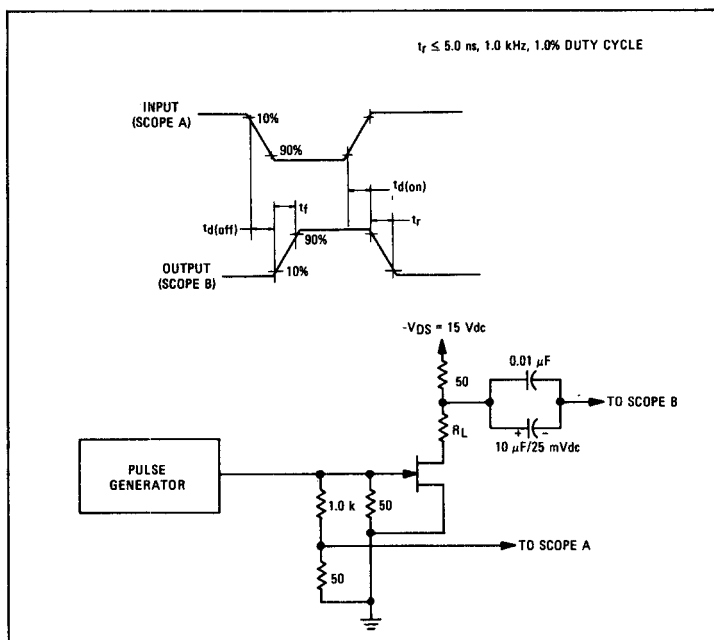


STYLE 4:
PIN 1. SOURCE
2. DRAIN
3. GATE & CASE

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	25	Vdc
Drain-Gate Voltage	V_{DG}	25	Vdc
Gate-Source Voltage	V_{GS}	25	Vdc
Forward Gate Current	$I_{G(f)}$	50	mAdc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$	P_D	1.8	Watt
Derate above 25°C		10	mW/ $^\circ\text{C}$
Operating Junction Temperature Range	T_J	-65 to +175	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-65 to +200	$^\circ\text{C}$

FIGURE 1 – SWITCHING TIMES TEST CIRCUIT



MFE2010, MFE2011, MFE2012 (continued)

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Gate-Source Breakdown Voltage (I _G = 10 μ Adc, V _{DS} = 0)	V _{(BR)GSS}	25	-	Vdc
Gate Reverse Current (V _{GS} = 15 Vdc, V _{DS} = 0)	I _{GSS}	-	3.0	nAdc
(V _{GS} = 15 Vdc, V _{DS} = 0, T _A = 150°C)		-	6.0	μ Adc
Drain Cutoff Current (V _{DS} = 15 Vdc, V _{GS} = 12 Vdc)	I _{D(off)}	-	3.0	nAdc
(V _{DS} = 15 Vdc, V _{GS} = 12 Vdc, T _A = 150°C)		-	6.0	μ Adc

ON CHARACTERISTICS

Zero-Gate Voltage Drain Current (†) (V _{DS} = 20 Vdc, V _{GS} = 0)	MFE2010 MFE2011 MFE2012	I _{DSS}	15 40 100	- - -	mAdc
Gate-Source Voltage (V _{DS} = 15 Vdc, I _D = 1.0 μ Adc)	MFE2010 MFE2011 MFE2012	V _{GS}	0.5 1.0 3.0	10 10 10	Vdc
Gate-Source Forward Voltage (I _G = 1.0 mAdc, V _{DS} = 0)		V _{GSF}	-	1.0	Vdc
Drain-Source "ON" Voltage (I _D = 8.0 mAdc, V _{GS} = 0)	MFE2010	V _{DS(on)}	-	0.75	Vdc
(I _D = 15 mAdc, V _{GS} = 0)	MFE2011		-	0.75	
(I _D = 30 mAdc, V _{GS} = 0)	MFE2012		-	0.75	
Static Drain-Source "ON" Resistance (I _D = 1.0 mAdc, V _{GS} = 0)	MFE2010 MFE2011 MFE2012	r _{DS(on)}	- - -	25 15 10	Ohms

SMALL-SIGNAL CHARACTERISTICS

Static Drain-Source "ON" Resistance (V _{GS} = 0, I _D = 0, f = 1.0 kHz)	MFE2010 MFE2011 MFE2012	r _{ds(on)}	- - -	25 15 10	Ohms
Input Capacitance (V _{DS} = 0, V _{GS} = 10 Vdc, f = 1.0 MHz)		C _{iss}	-	50	pF
Reverse Transfer Capacitance (V _{DS} = 0, V _{GS} = 12 Vdc, f = 1.0 MHz)		C _{rss}	-	20	pF

SWITCHING CHARACTERISTICS

Turn-On Delay Time (See Figure 1)		t _{d(on)}	-	10	ns
Rise Time (See Figure 1)		t _r	-	6.0	ns
Turn-Off Delay Time (See Figure 1) (V _{DD} = 15 Vdc, I _D = 8.0 mAdc)	MFE2010	t _{d(off)}	-	35	ns
(V _{DD} = 15 Vdc, I _D = 15 mAdc)	MFE2011		-	20	
(V _{DD} = 15 Vdc, I _D = 30 mAdc)	MFE2012		-	12	
Fall Time (See Figure 1) (V _{DD} = 15 Vdc, I _D = 8.0 mAdc)	MFE2010	t _f	-	75	ns
(V _{DD} = 15 Vdc, I _D = 15 mAdc)	MFE2011		-	45	
(V _{DD} = 15 Vdc, I _D = 30 mAdc)	MFE2012		-	25	

(†) Pulse Test: Pulse Width $\leq$ 300 μ s, Duty Cycle $\leq$ 3.0%.